

April 2013

FGA180N33ATD 330 V PDP Trench IGBT

Features

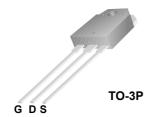
- · High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.68 V @ I_C = 180 A
- · High Input Impedance
- RoHS Complaint

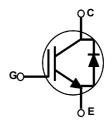
Applications

• PDP TV

General Description

Using novel trench IGBT Technology, Fairchild®'s new series of trench IGBTs offer the optimum performance for PDP TV applications where low conduction and switching losses are essen-





Absolute Maximum Ratings

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		330	V
V _{GES}	Gate to Emitter Voltage		± 30	V
I _C	Collector Current	$@ T_C = 25^{\circ}C$	180	Α
I _{CM (1)}	Pulsed Collector Current	@ T _C = 25°C	450	А
P _D	Maximum Power Dissipation	@ T _C = 25°C	390	W
. 0	Maximum Power Dissipation	@ T _C = 100°C	156	W
T _J	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes: 1: Repetitive test, pulse width = 100usec, Duty = 0.1

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction to Case	-	0.32	°C/W
$R_{\theta JC}(Diode)$	Thermal Resistance, Junction to Case	-	0.82	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		40	°C/W

^{*} I_{C_}pulse limited by max Tj

Package Marking and Ordering Information

			Packaging		Max Qty per	
Device Marking	Device	Package	Type	Qty per Tube	Вох	
FGA180N33ATD	FGA180N33ATDTU	TO-3P	Tube	30ea	-	

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 400 \mu A$	330	-	-	V
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0V	-	-	400	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 250uA, V _{CE} = V _{GE}	2.5	4.0	5.5	V
		I _C = 40A, V _{GE} = 15V	-	1.1	1.4	V
Vorum	Collector to Emitter Saturation Voltage	I _C = 180A, V _{GE} = 15V,	-	1.68	-	V
V _{CE(sat)} Collector to Emitter Saturation Voltage	I _C = 180A, V _{GE} = 15V T _C = 125°C	-	1.89	-	٧	
Dynamic C	haracteristics	•		•	•	
C _{ies}	Input Capacitance		-	3880	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30V_{V_{GE}} = 0V_{SE}$	-	305	-	pF
C _{res}	Reverse Transfer Capacitance	T = TIVITIZ	-	180	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	27	-	ns
t _r	Rise Time	$V_{CC} = 200V, I_{C} = 40A,$	-	80	-	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 5\Omega$, $V_{GE} = 15V$, Resistive Load, $T_C = 25^{\circ}C$	-	108	-	ns
t _f	Fall Time		-	180	240	ns
t _{d(on)}	Turn-On Delay Time		-	26	-	ns
t _r	Rise Time	$V_{CC} = 200V, I_C = 40A,$	-	75	-	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 5\Omega$, $V_{GE} = 15V$, Resistive Load, $T_C = 125^{\circ}C$	-	112	-	ns
t _f	Fall Time		-	250	300	ns
Qg	Total Gate Charge		-	169	-	nC
Q _{ge}	Gate to Emitter Charge	$V_{CE} = 200V, I_{C} = 40A,$ $V_{GE} = 15V$	-	22	-	nC
Q _{gc}	Gate to Collector Charge	vGE - 13v	-	69	-	nC

Electrical Characteristics of the Diode $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 20A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1.2	1.6	V
FIVI	Ziode i ei mara venage		$T_{\rm C}$ = 125 $^{\rm o}$ C	-	1.04	-	•
t _{rr}	Diode Reverse Recovery Time		$T_C = 25^{\circ}C$	-	27	-	ns
ALL.	2.000	I _{ES} =20A,	$T_{\rm C}$ = 125°C	-	39	-	
Irr	Diode Peak Reverse Recovery Cyrrent	dI/dt = 200A/μs	T _C = 25°C	-	3.5	-	Α
יוו	Block Four Novelee Receivery Symony		T _C = 125°C	-	6.0	-	,,
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	-	48	-	nC
α Π	Diago Neverso Necessary energe		T _C = 125°C	1	117	-	110

Figure 1. Typical Output Characteristics

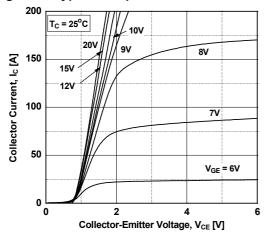


Figure 3. Typical Saturation Voltage Characteristics

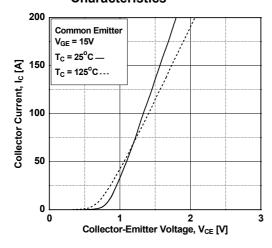


Figure 5. Saturation Voltage vs. Case
Temperature at Variant Current Level

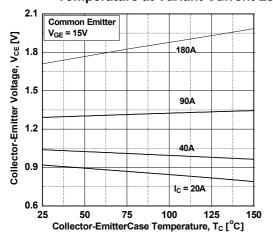


Figure 2. Typical Output Characteristics

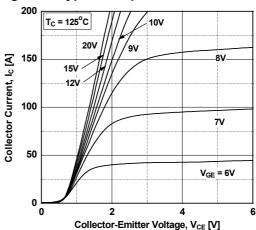


Figure 4. Transfer Characteristics

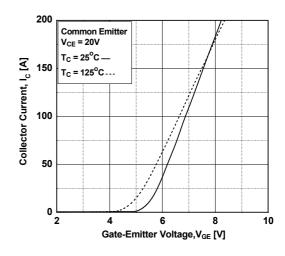


Figure 6. Saturation Voltage vs. V_{GE}

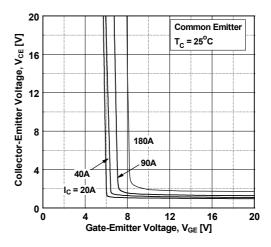


Figure 7. Saturation Voltage vs. V_{GE}

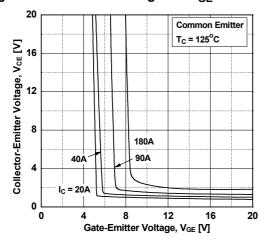


Figure 9. Gate charge Characteristics

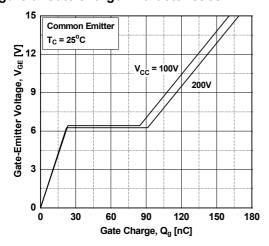


Figure 11. Turn-on Characteristics vs.
Gate Resistance

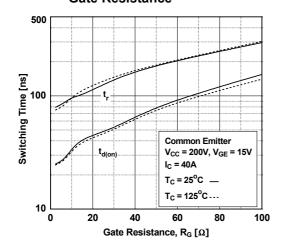


Figure 8. Capacitance Characteristics

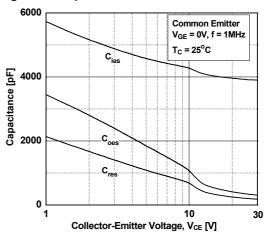


Figure 10. SOA Characteristics

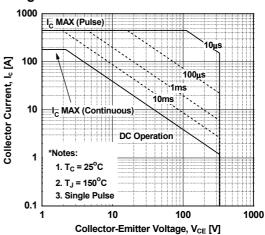


Figure 12. Turn-off Characteristics vs.
Gate Resistance

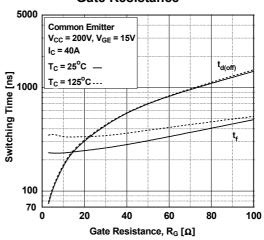


Figure 13. Turn-on Characteristics vs. Collector Current

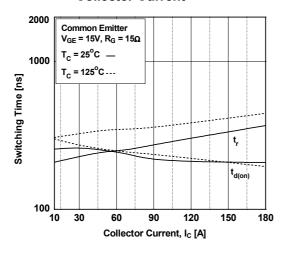


Figure 14. Turn-off Characteristics vs.
Collector Current

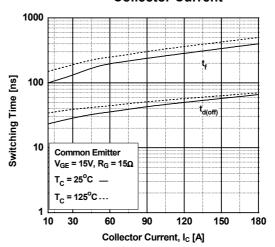


Figure 15. Turn off Switching SOA Characteristics Fig

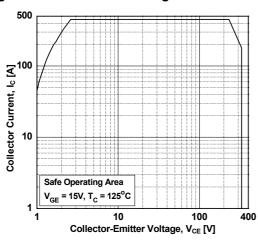


Figure 16. Forward Characteristics

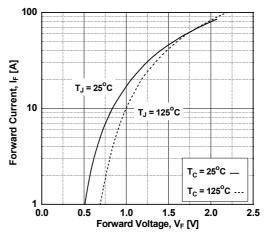


Figure 19. Reverse Recovery Current

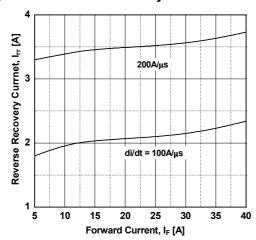


Figure 20. Stored Charge

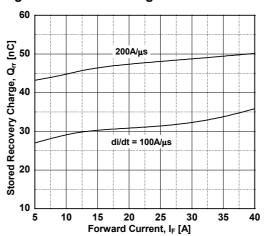


Figure 21.Reverse Recovery Time

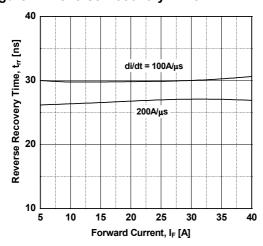
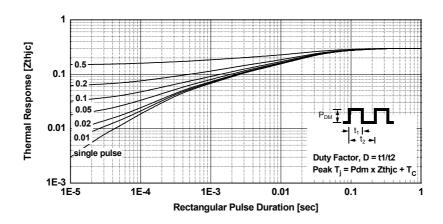
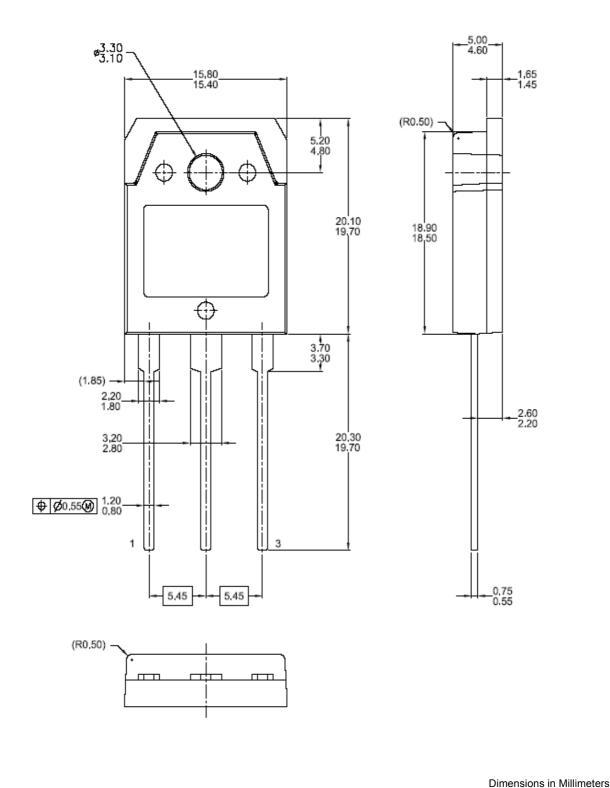


Figure 22. Transient Thermal Impedance of IGBT



Mechanical Dimensions

TO-3PN







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